



Product Change Notification

Change Notification #: 116365 - 00
Change Title: Intel® Power Distribution Board FUPPDBHC2, PCN 116365-00, Product Design, Increase PMBus cable length extension from 250mm to 280mm
Date of Publication: July 12, 2018

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	July 27, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following change on the Intel® Power Distribution Board FUPPDBHC2:

- The PMBus cable length extension has been increased from 250 mm to 280 mm to allow an easier connection with the latest generation on Intel® Server Motherboard S2600ST family.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand these changes and determine the impact on their applications.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
FUPPDBHC2	936420	H46623-001	H46623-002

PCN Revision History:

Date of Revision: July 12, 2018	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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